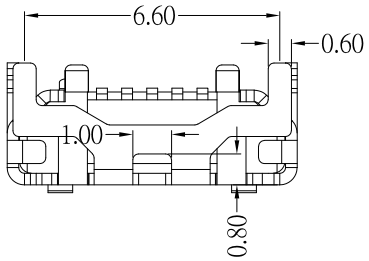
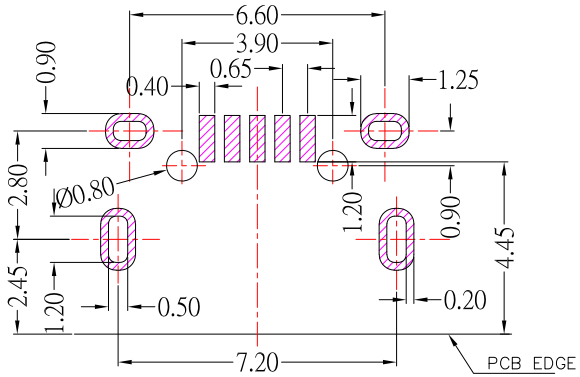
MRUSB-5BED14Bx-S347

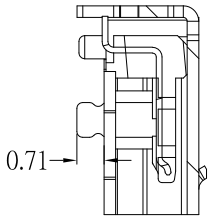
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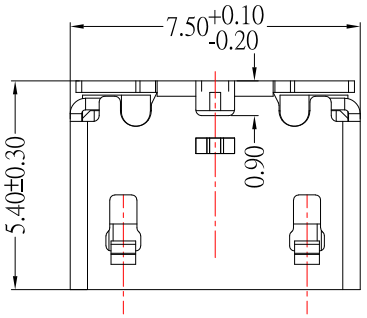
TN
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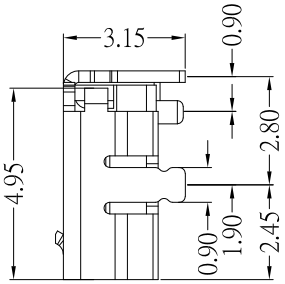


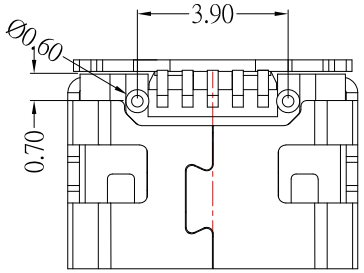


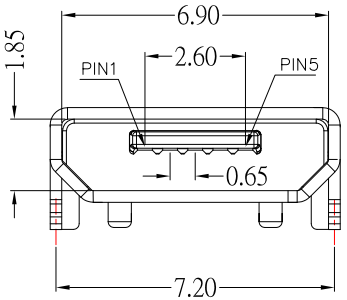
P.C.B LAYOUT











NOTES:

1.MATERIAL:

1.1 HOUSING: LCP

1.2 CONTACT: PHOSPHOR BRONZE

1.3 SHELL: SUS

2.Finish:

2.1 Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall

2.2 Shell: Tin or Nickel under Plated surface layer

3.SPECIFICATION:

3.1 CURRENT RATING: 1.8 A (PIN1,5) ; 1.0 A(PIN2,3,4)

3.2 DIELECTRIC WITHSSTANDING VOLTAGE: 100 V(ac) FOR 1min

3.3 CONTACT RESISTANCE: 30 mΩ MAX.

3.4 INSULATION RESISTANCE: 100 MΩ MIN.

3.5 TOTAL MATING FORCE: 3.57 Kgf MAX.

3.6 TOTAL UNMATING FORCE: 1.0 Kgf MIN.

3.7 TEMPERATURE RANGE: -30°C ~ +80°C

ITEM NO.	DESCRIPTION	DRAWN	DATE
2	更新Housing樣式	Jack	122625
1	新增尺寸	Jack	082923

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ± 0.2
Above 5 ~ 15 ± 0.3
Above 15 ~ 30 ± 0.4
Above 30 ~ 50 ± 0.5
Angle ± 0.3°

3RD. ANGEL'S | UNITS | MM

DRAWN BY:	Jack Lu	DATE 12/26/25
CHECKED BY:	Jacky Chen	DATE 12/26/25
APPROVED BY:	Tony Kao	DATE 12/26/25

MAT'L		TITLE	CONNECTOR
FINISH		MODLE	MICRO USB 5BF 牛角(PH7.2-6.6) 有柱,無捲邊
SCALE	1 : 1	DWG NO.	MRUSB5B-ED14Bx-S347 SIZE A4
SHEET NO.	1 of 1	PART NO.	MRUSB5B-ED14Bx-S347 VER R2